BGF108

7 Channel LCD Filter Array with ESD Protection

Small Signal Discretes



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BGF108

Revision History: 2007-12-10, V2.0

Previous Version: 2006-12-14, V1.4

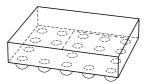
Page	Subjects (major changes since last revision)					
All	Preliminary status removed					
5	Table 1 and Table 2 updated					
6	Line capacitance, Insertion Loss and Analog Cross Talk curves updated					
7	Package and tape drawing updated					



7 Channel LCD Filter Array with ESD Protection

Feature

- 7 channel integrated RC filter array
- ESD protection according to IEC61000-4-2 up to 15 kV contact discharge on all IOs
- Wafer Level Package with SnAgCu solder balls
- 400 µm solder ball pitch
- · RoHS and WEEE compliant package



WLP-18-1-N-3D



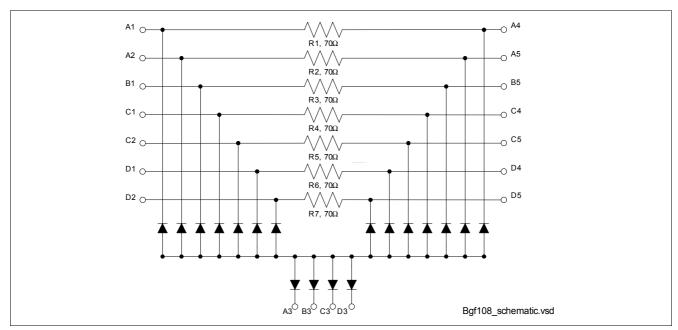


Figure 1 Schematic

Description

The BGF108 is a 7 channel RC filter array to provide EMI attenuation of undesired signals in the 800 - 2000 MHz range. All pins are protected against ESD up to 15 kV according to IEC61000-4-2 (contact discharge). The wafer level package is a green package with a size of only 1.68 mm x 2.02 mm and a total height of 0.60 mm.

Туре	Package	Marking	Chip
BGF108	WLP-18-1	BGF108	N0715



Table 1 Maximum Ratings

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Voltage at all pins to GND	V_{P}	0		5	V	
Operating temperature range	T_{OP}	-40		+85	°C	
Storage temperature range	T_{STG}	-65		+150	°C	
Summed up input power for all pins	P_{IN}			60	mW	T _S < 70 °C
Electrostatic discharge according to IEC61000-4-2 ¹⁾ at all pins	V_{E}	-15		15	kV	

¹⁾ Contact discharge

Table 2 Electrical Characteristics¹⁾

Parameter	Symbol	l Values			Unit	Note /
		Min.	Typ.	Max.		Test Condition
Series Resistors R_1R_{10}	R	56	70	84	Ω	
Leakage current of each line to GND	I_{R}		1 2	100 1000	nA	$V_{\rm R}$ = 3 V $V_{\rm R}$ = 5 V
Breakdown voltage of each line to GND	$V_{(BR)}$	7	8.2		V	$I_{(BR)} = 1 \text{ mA}$
Line capacitance of each line to GND	C_{T}		27 17	30	pF	$V_{R} = 0 \text{ V}$ $V_{R} = 3 \text{ V}$

¹⁾ at T_A = 25 °C

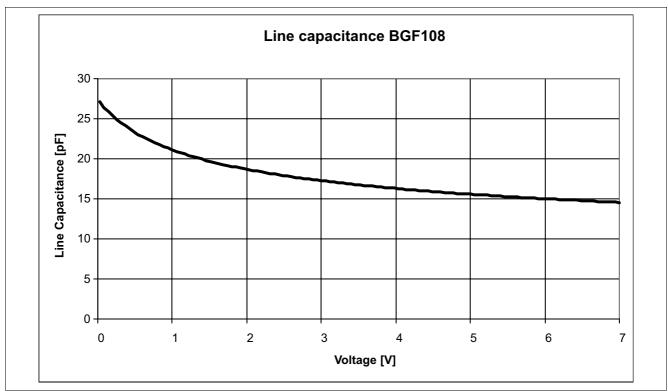


Figure 2 Capacitance of one line to GND versus DC voltage



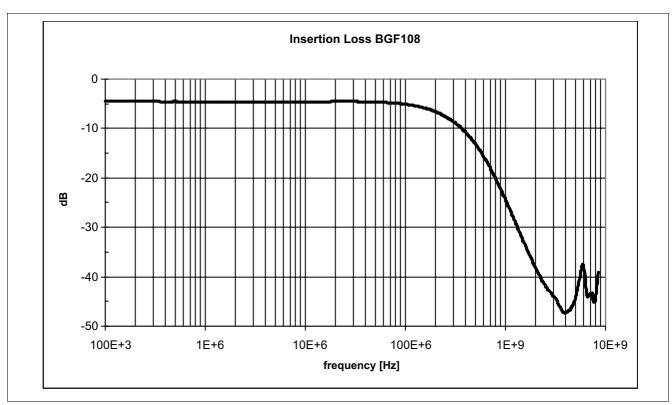


Figure 3 Typical filter characteristics of on channel ($Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω , $V_{\rm R}$ = 0 V)

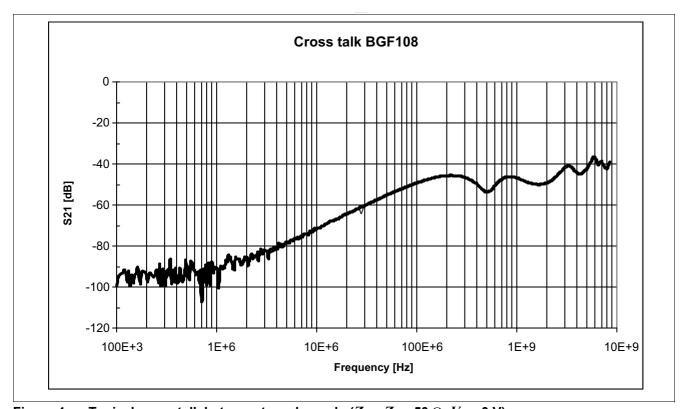


Figure 4 Typical cross talk between two channels ($Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω , $V_{\rm R}$ = 0 V)



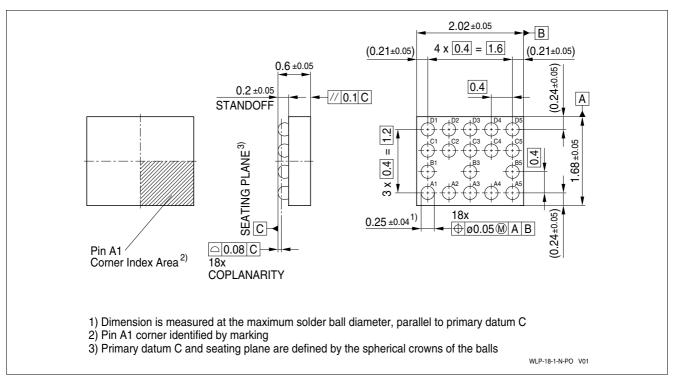


Figure 5 Package WLP-18-1

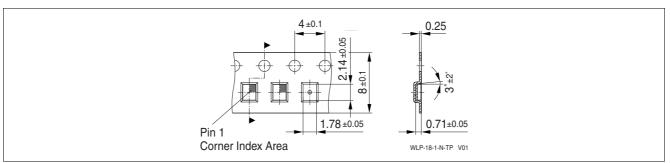


Figure 6 Tape of WLP-18-1